## Silicon Schottky Barrier Diode for Rectifying

# HITACHI

ADE-208-163D(Z) Rev 4 Jul. 1997

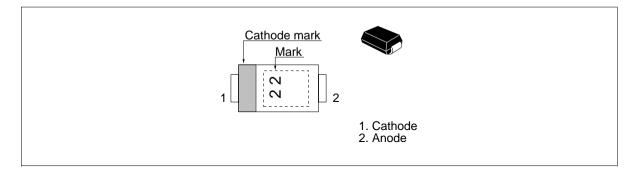
#### Features

- Good for high-frequency rectify.
- LRP structure ensures higher reliability.

#### **Ordering Information**

Туре No.	Laser Mark	Package Code
HRF22	22	LRP

#### Outline





## Absolute Maximum Ratings (Ta = $25^{\circ}$ C)

Item	Symbol	Value	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub> <sup>*1</sup>	40	V
Average rectified current	<sub>o</sub> *1	1.0	A
Non-Repetitive peak forward surge current	I <sub>FSM</sub> <sup>*2</sup>	20	A
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-40 to +125	٥C

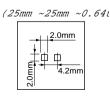
Note: 1. See from Fig.4 to Fig.7

Note: 2. 10msec half sine wave 1 pulse

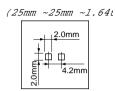
#### Electrical Characteristics (Ta = $25^{\circ}$ C)

ltem	Symbol	Min	Тур	Мах	Unit	Test Condition
Forward voltage	V <sub>F</sub>	_	_	0.55	V	I <sub>F</sub> = 1.0A
Reverse current	I <sub>R</sub>	—	—	1.0	mA	V <sub>R</sub> = 40V
ESD-Capability	—	150	—	_	V	C=200pF , R=0 $\Omega$ , Both forward and reverse direction 1 pulse.
Thermal resistance	Rth(j-a)	_	_	108	°C/W	Alumina board <sup>1</sup>
		_		157		Print board <sup>*2</sup>

#### Note: 1. Alumina board



Note: 2. Print board



#### HITACHI

## **Main Characteristic**

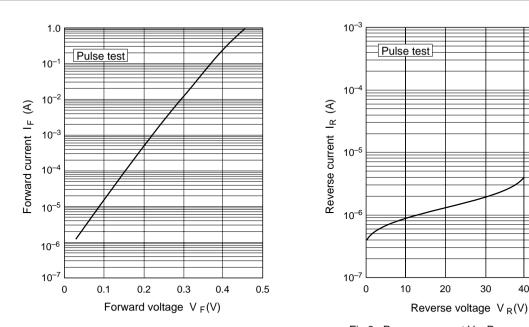
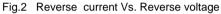


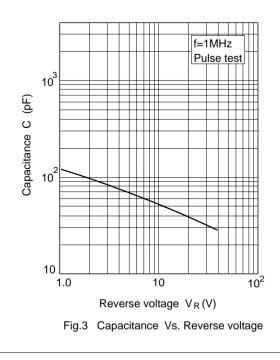
Fig.1 Forward current Vs. Forward voltage



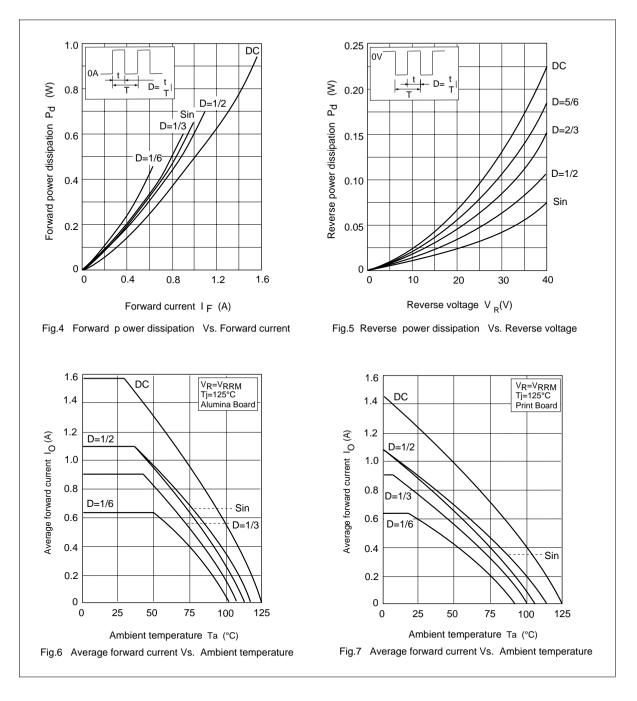
30

40

50



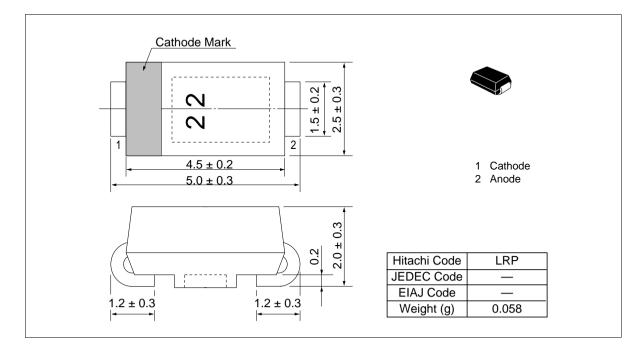
#### **Main Characteristic**



#### HITACHI

## **Package Dimensions**

Unit : mm



#### Cautions

- Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
- 2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- 3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
- 4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
- 5. This product is not designed to be radiation resistant.
- 6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
- 7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.



Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109 NorthAmerica URL http:semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg Europe http://www.has.hitachi.com.sg/grp3/sicd/index.htm http://www.hitachi.com.tw/E/Product/SICD\_Frame.htm Asia (Singapore) Asia (Taiwan) Asia (HongKong) http://www.hitachi.com.hk/eng/bo/grp3/index.htm http://www.hitachi.co.jp/Sicd/indx.htm Japan For further information write to: Hitachi Semiconductor Hitachi Europe GmbH Hitachi Asia Pte. Ltd. (America) Inc. Electronic components Group 16 Collyer Quay #20-00 179 East Tasman Drive, Dornacher Stra§e 3 Hitachi Tower San Jose,CA 95134 D-85622 Feldkirchen, Munich Singapore 049318 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Germany Tel: 535-2100 Tel: <49> (89) 9 9180-0 Fax: 535-1533 Fax: <49> (89) 9 29 30 00

 Fax: <49> (89) 9 29 30 00
 Hita

 Hitachi Europe Ltd.
 Hita

 Electronic Components Group.
 Taip

 Whitebrook Park
 3F,

 Lower Cookham Road
 Tun

 Maidenhead
 Tel:

 Berkshire SL6 8YA, United Kingdom
 Fax

 Tel: <44> (1628) 585000

 Fax: <44> (1628) 778322

Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180

HITACHI

Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

Copyright ' Hitachi, Ltd., 1999. All rights reserved. Printed in Japan.